SON8-P-0303-0.65A

Weight: 0.017 g (typ.)

TOSHIBA

Toshiba BiCD Integrated Circuit Silicon Monolithic

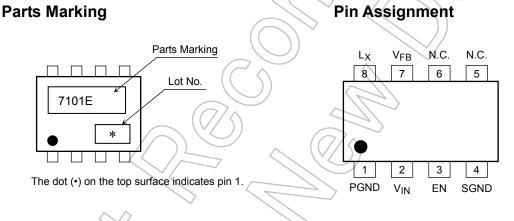
# TB7101F(T5L3.3,F)

Buck DC-DC Converter IC

The TB7101F is a single-chip buck DC-DC converter IC. The TB7101F contains high-speed and low-on-resistance power MOSFETs for the main switch and synchronous rectifier to achieve high efficiency.

### Features

- Enables up to 1 A of load current (I<sub>OUT</sub>) with a minimum of external components.
- Fixed output voltage: VOUT = 3.3 V (typ.)
- A high 1-MHz oscillation frequency (typ.) allows the use of small external components.
- Uses only an inductor and two capacitors to achieve high efficiency.
- Allows the use of a small surface-mount ceramic capacitor as an output filter capacitor,
- Housed in a small surface-mount package (PS-8) with a low thermal resistance.
- Undervoltage lockout (UVLO), thermal shutdown (TSD) and overcurrent protection (OCP)



\*: The lot number consists of three digits. The first digit represents the last digit of the year of manufacture, and the following two digits indicates the week of manufacture between 01 and either 52 or 53.

Manufacturing week code (The first week of the year is 01; the last week is 52 or 53.) Manufacturing year code (last digit of the year of manufacture)

This product has a MOS structure and is sensitive to electrostatic discharge. Handle with care.

The product(s) in this document ("Product") contain functions intended to protect the Product from temporary small overloads such as minor short-term overcurrent, or overheating. The protective functions do not necessarily protect Product under all circumstances. When incorporating Product into your system, please design the system (1) to avoid such overloads upon the Product, and (2) to shut down or otherwise relieve the Product of such overload conditions immediately upon occurrence. For details, please refer to the notes appearing below in this document and other documents referenced in this document.

Start of commercial production 2007-09

# <u>TOSHIBA</u>

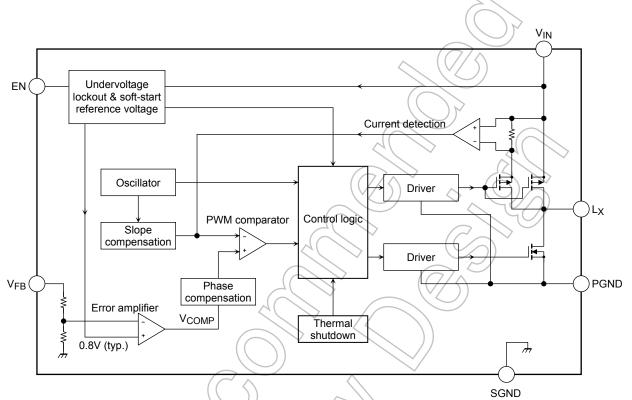
### **Ordering Information**

Part Number
TB7101F(T5L3.3,F)

Embossed tape (3000 units per reel)

Shipping

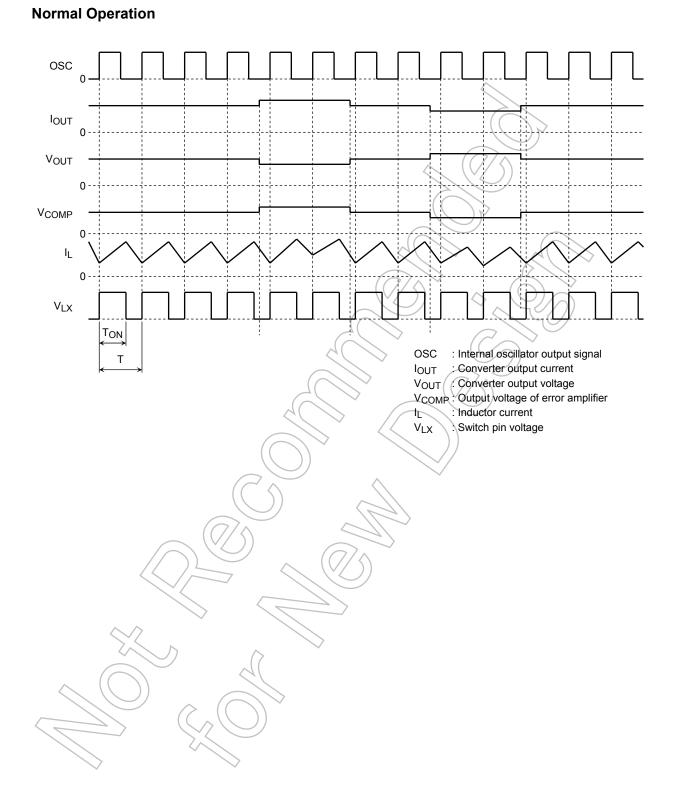
### Block Diagram



### **Pin Description**

Pin No.	Symbol	Description
1	PGND	Ground for the output section
2	VIN	Input pin This pin is placed in the standby state if $V_{ENB}$ = low. Standby current is 1 $\mu$ A or less.
3	EN	Enable pin This pin is connected to an on-chip CMOS inverter. When EN $\ge$ 3.5 V (@V <sub>IN</sub> = 5 V), the control logic is allowed to operate and thus enable the switching operation of the output section.
4	SGND	Ground for the control logic
5	N.C.	No-connect
6	N.C.	No-connect
7	V <sub>FB</sub>	Feedback pin Output voltage is set to 3.3 V (typ.) internally.
8	L <sub>X</sub>	Switch pin This output is connected to the high-side P-channel MOSFETs and low-side N-channel MOSFET.

### **Timing Chart**



### Absolute Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
Input voltage		V <sub>IN</sub>	V <sub>IN</sub> –0.3 to 6	
Enable pin voltage		V <sub>EN</sub>	–0.3 to 6	V
V <sub>EN</sub> –V <sub>IN</sub> voltage difference		$V_{\text{EN}} - V_{\text{IN}}$	$V_{EN}-V_{IN}<0.3$	V
Feedback pin voltage		V <sub>FB</sub>	-0.3 to 6	V
Switch pin voltage		$V_{LX}$	-0.3 to 6	V
Switch pin current		I <sub>LX</sub>	±1.3	А
Power dissipation	(Note 1)	PD	0.7	w
Operating junction temperature		Tjopr	-40 to 125	°C
Junction temperature (Note 2)		Tj	150	°C
Storage temperature		T <sub>stg</sub>	-55 to 150	°C

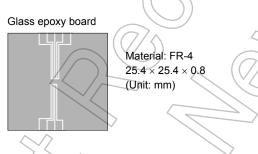
Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc)

### **Thermal Resistance Characteristic**

	21			
Characteristics	Symbol	Max	Unit	
Thermal resistance, junction and ambient	R <sub>th</sub> (j-a)	178.6 (Note 1)	°C/W	

Note 1:



Note 2: The TB7101F may go into thermal shutdown at the rated maximum junction temperature. Thermal design is required to ensure that the rated maximum operating junction temperature, T<sub>jopr</sub>, will not be exceeded.



### Electrical Characteristics (unless otherwise specified: $T_j = 25^{\circ}C$ and $V_{IN} = 4.3$ to 5.5 V)

### TB7101F (T5L3.3, F)

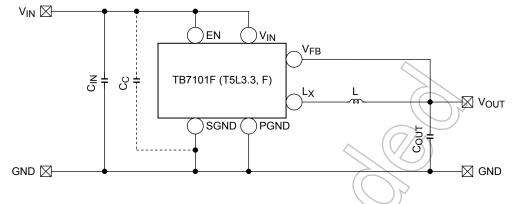
Characteristics		Symbol	Test Condition		Тур.	Max	Unit
Operating input voltage		V <sub>IN (OPR)</sub>		4.3	_	5.5	V
Operating current		I <sub>IN1</sub>	$V_{IN}$ = 5 V, $V_{EN}$ = 5 V, $V_{FB}$ = 5 V	Y	0.68	0.9	mA
		I <sub>IN2</sub>	$V_{IN} = 4.3 \text{ V}, V_{EN} = 4.3 \text{ V}, V_{FB} = 4.3 \text{ V}$		0.64	0.775	mA
Standby current		I <sub>IN (STBY)</sub>	$V_{IN} = 5 \text{ V},  V_{EN} = 0 \text{ V},  V_{FB} = 0 \text{ V}$	Æ	-((	1	μA
EN threshold voltage		V <sub>IH (EN) 1</sub>	V <sub>IN</sub> = 5 V	3.5		_	V
		V <sub>IH (EN) 2</sub>	V <sub>IN</sub> = 4.3 V	3.01		_	V
		V <sub>IL (EN) 1</sub>	V <sub>IN</sub> = 5 V			1.5	V
		V <sub>IL (EN) 2</sub>	V <sub>IN</sub> = 4.3 V	_	_	1.29	V
EN input current		l <sub>IH</sub> (EN) 1	$V_{IN} = 5 V, V_{EN} = 5 V$	7.6	Æ	12.4	μA
		l <sub>IH</sub> (EN) 2	$V_{IN} = 4.3 \text{ V}, V_{EN} = 4.3 \text{ V}$	6.54	Þ	10.66	μA
		V <sub>FB1</sub>	$V_{IN} = 5 V, V_{EN} = 5 V, 1_{OUT} = 10 \text{ mA}$	3.201	3.3	3.399	V
VFB input voltage		V <sub>FB2</sub>	$V_{IN} = 4.3 \text{ V}, V_{EN} = 4.3 \text{ V}, I_{OUT} = 10 \text{ mA}$	3.201	3.3	3.399	V
High-side switch o	n-state resistance	R <sub>DS (ON) (H)</sub>	$V_{IN} = 5 \text{ V}, V_{EN} = 5 \text{ V}, I_{LX} = -0.5 \text{ A}$	K	0.27	_	Ω
Low-side switch or	n-state resistance	R <sub>DS (ON) (L)</sub>	$V_{IN} = 5 V$ , $V_{EN} = 5 V$ , $I_{LX} = 0.5 A$		0.27		Ω
High-side switch le	eakage current	I <sub>LEAK (H)</sub>	$V_{IN} = 5 V, V_{EN} = 0 V, V_{LX} = 0 V$	$\mathcal{A}$		-1	μA
Low-side switch le	akage current	ILEAK (L)	$V_{IN} = 5 V, V_{EN} = 0 V, V_{LX} = 5 V$	-		1	μA
Oscillation frequency		f <sub>osc1</sub>	$V_{IN} = 5 V, V_{EN} = 5 V$	0.85	1	1.15	MHz
		f <sub>osc2</sub>	V <sub>IN</sub> = 4.3 V, V <sub>EN</sub> = 4.3 V	0.85	1	1.15	MHz
Soft-start time		t <sub>ss1</sub>	$V_{IN} = 5 V, V_{EN} = 5 V, I_{OUT} = 0 A$	1	2		ms
Solt-start time		t <sub>ss2</sub>	$V_{IN} = 4.3 \text{ V}, \text{ V}_{EN} = 4.3 \text{ V}, \text{ I}_{OUT} \neq 0 \text{ A}$	1.2	2.4		ms
Thermal shutdown (TSD)	Detection temperature	T <sub>SD</sub>	V <sub>IN</sub> = 5 V		160		°C
shuldown (TSD)	Hysteresis	ATSD	V <sub>IN</sub> = 5 V	_	20	_	°C
	Detection voltage	Vuv	VIN = VEN	2.2	2.4	2.6	V
Undervoltage lockout (UVLO)	Recovery voltage	V <sub>UVR</sub>	VIN = VEN	2.3	2.5	2.7	V
	Hysteresis	ΔV <sub>UV</sub>	VIN = VEN		0.1		V
Lx current limit		ILIM	$V_{IN} = 5 V$	1.3	2.8	_	А

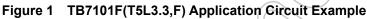
### Note on Electrical Characteristics

The test condition  $T_j = 25^{\circ}C$  means a state where any drifts in electrical characteristics incurred by an increase in the chip's junction temperature can be ignored during pulse testing.



### **Application Circuit Example**





Component values (@TB7101F (T5L3.3, F), VIN = 5 V, Ta = 25°C)

These values are presented only as a guide.

- $C_{IN}$ : Input filter capacitor = 10  $\mu$ F
  - (ceramic capacitor: GRM21BB30J106K from Murata Manufacturing Co., Ltd.)
- $C_{OUT}$ : Output filter capacitor = 10  $\mu F$ 
  - (ceramic capacitor: GRM21BB30J106K from Murata Manufacturing Co., Ltd.)
- L: Inductor = 3.3  $\mu$ H (NP04SB3R3N from Taiyo Yuden Co., Ltd.)

Component values need to be adjusted, depending on the TB7101F's input/output conditions and the board layout.

### Application Notes

#### Inductor Selection

The inductance required for inductor L can be calculated as follows:

- $L = \frac{V_{IN} V_{OUT}}{f_{osc} \cdot \Delta I_L} \underbrace{V_{OUT}}_{V_{IN}} \underbrace{.....(1)}_{V_{IN}} \underbrace{V_{IN}}_{V_{IN}} \underbrace{V_{IN}}_{V_{IN}} \underbrace{V_{IN}}_{V_{IN}} \underbrace{V_{IN}}_{V_{IN}} \underbrace{V_{IN}}_{Oscillation frequency = 1 MHz (typ.)}_{V_{IL}} \underbrace{V_{IN}}_{V_{IN}} \underbrace{V_{IN}} \underbrace{V_{IN}}_{V_{IN}} \underbrace{V_{IN}}_{V_{IN}} \underbrace{V_{IN}}_{V_{IN}} \underbrace{V_{IN}}_{V_{IN}} \underbrace{V_{IN}}_{V_{IN}} \underbrace{V_{IN}}_{V_{IN}} \underbrace{V_{IN}}_{V_{IN}} \underbrace{V_{IN}}_{V_{IN}} \underbrace{V_{IN}}_{V_{IN}} \underbrace{V_{IN}} \underbrace{V_{IN}} \underbrace{V_{IN}} \underbrace{V_{IN}} \underbrace{V_{IN}} \underbrace{V_{IN}} \underbrace{V_{IN}}$
- \*: Generally, ∆IL should be set to approximately 30% of the maximum output current. Since the maximum output current of the TB7101F is 1 A, ∆IL should be 0.3 A or so. Therefore, the inductor should have a current rating greater than the peak output current of 1.15 A. If the inductor current rating is exceeded, the inductor becomes saturated, leading to an unstable DC-DC converter operation.

When  $V_{IN} = 5$  V, the required inductance can be calculated as follows. Be sure to select an appropriate inductor, taking the VIN range into account.

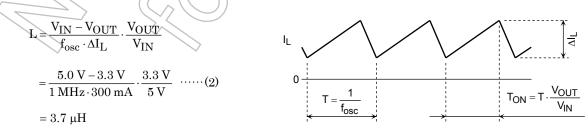


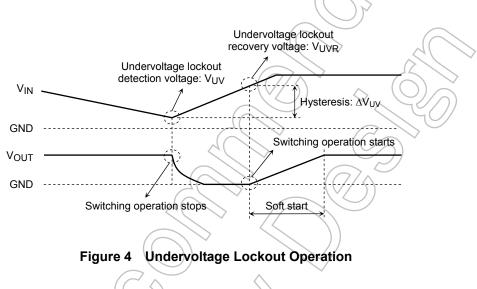
Figure 2 Inductor Current Waveform

#### **Output Capacitor Selection**

Use a ceramic capacitor as the output filter capacitor. Since a ceramic capacitor is generally sensitive to temperature, choose one with excellent temperature characteristics (such as the JIS B characteristic). As a rule of thumb, its capacitance should be  $10 \,\mu\text{F}$  or greater. The capacitance should be set to an optimal value that meets the system's ripple voltage requirement and transient load response characteristics. Since the ceramic capacitor has a very low ESR value, it helps reduce the output ripple voltage; however, because the ceramic capacitor provides less phase margin, it should be thoroughly evaluated.

#### **Undervoltage Lockout (UVLO)**

The TB7101F has undervoltage lockout (UVLO) protection circuitry. The TB7101F does not provide output voltage ( $V_{OUT}$ ) until the input voltage has reached  $V_{UVR}$  (2.5 V typ.). UVLO has hysteresis of 0.1 V (typ.). After the switch turns on, if  $V_{IN}$  drops below  $V_{UV}$  (2.4 V typ.), UVLO shuts off the switch at  $V_{OUT}$ .



### Thermal Shutdown (TSD)

The TB7101F provides thermal shutdown. When the junction temperature continues to rise and reaches TSD (160°C typ.), the TB7101F goes into thermal shutdown and shuts off the power supply. TSD has a hysteresis of about 20°C. The device is enabled again when the junction temperature has dropped by approximately 20°C from the TSD trip point. The device resumes the power supply when the soft-start circuit is used upon recovery from the TSD state.

Thermal shutdown is intended to protect the device against abnormal system conditions. It should be ensured that the TSD circuit will not be activated during normal operation of the system.

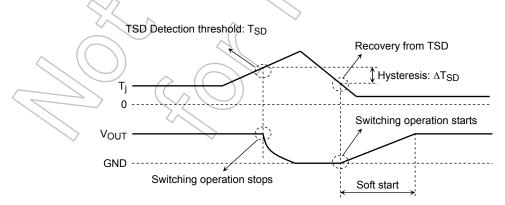
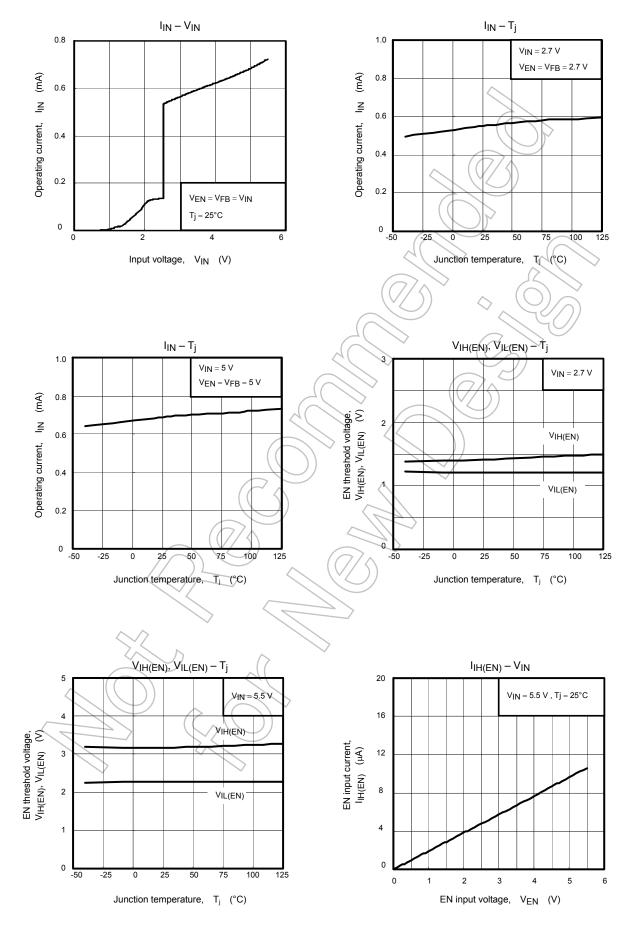


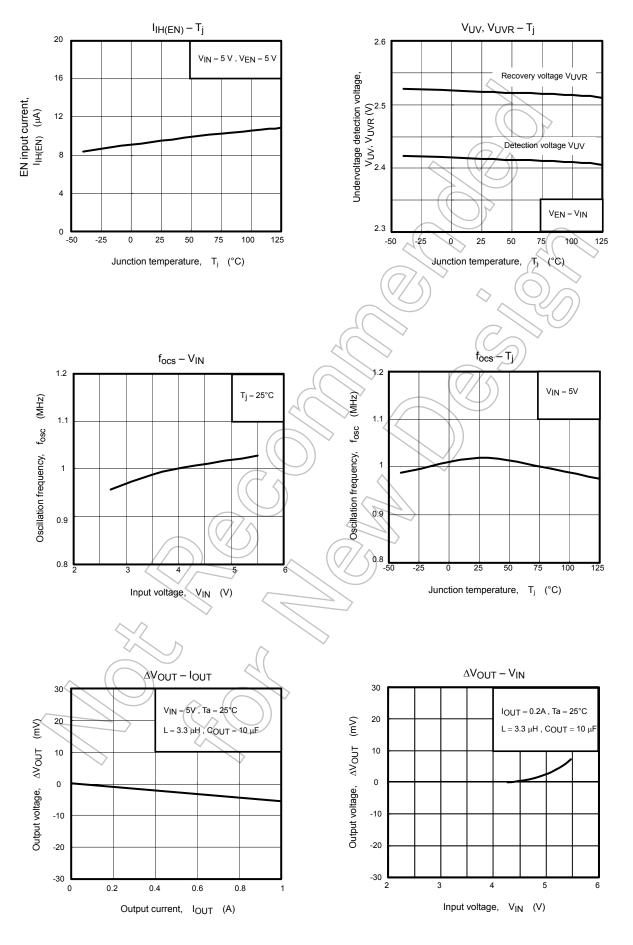
Figure 5 Thermal Shutdown Operation

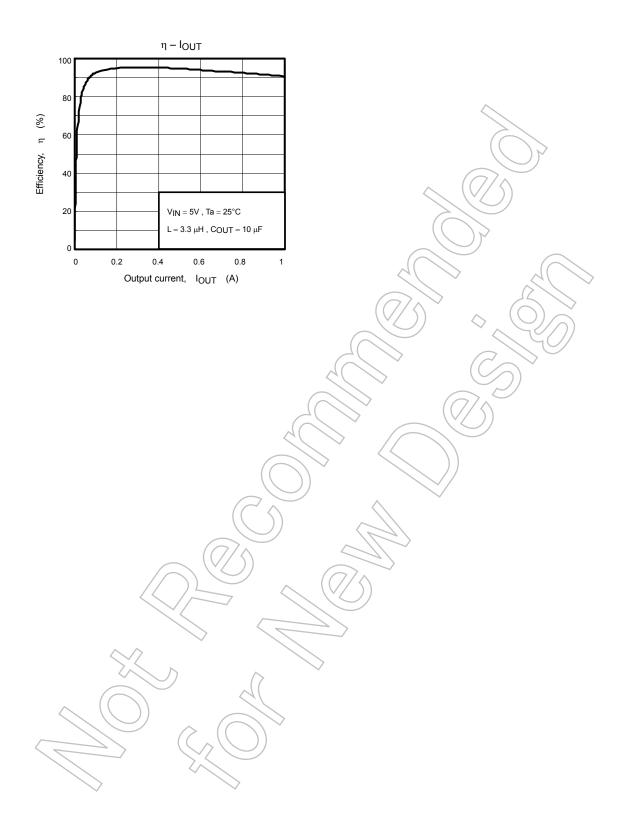
### **Usage Precautions**

- The input voltage, output voltage, output current and temperature conditions should be considered when selecting capacitors and inductors. These components should be evaluated on an actual system prototype for best selection.
- External components such as capacitors and inductor should be placed as close to the TB7101F as possible.
- The TB7101F has an ESD diode between the EN and VIN pins. The voltage between these pins should satisfy  $V_{EN} V_{IN} < 0.3$  V.
- Operation might become unstable due to board layout. In that case, add a decoupling capacitor (C<sub>C</sub>) of 0.1  $\mu F$  to 1 $\mu F$  between the SGND and V<sub>IN</sub> pins.
- The overcurrent protection circuits in the Product are designed to temporarily protect Product from minor overcurrent of brief duration. When the overcurrent protective function in the Product activates, immediately cease application of overcurrent to Product. Improper usage of Product, such as application of current to Product exceeding the absolute maximum ratings, could cause the overcurrent protection circuit not to operate properly and/or damage Product permanently even before the protection circuit starts to operate.
- The thermal shutdown circuits in the Product are designed to temporarily protect Product from minor overheating of brief duration. When the overheating protective function in the Product activates, immediately correct the overheating situation. Improper usage of Product, such as the application of heat to Product exceeding the absolute maximum ratings, could cause the overheating protection circuit not to operate properly and/or damage Product permanently even before the protection circuit starts to operate.

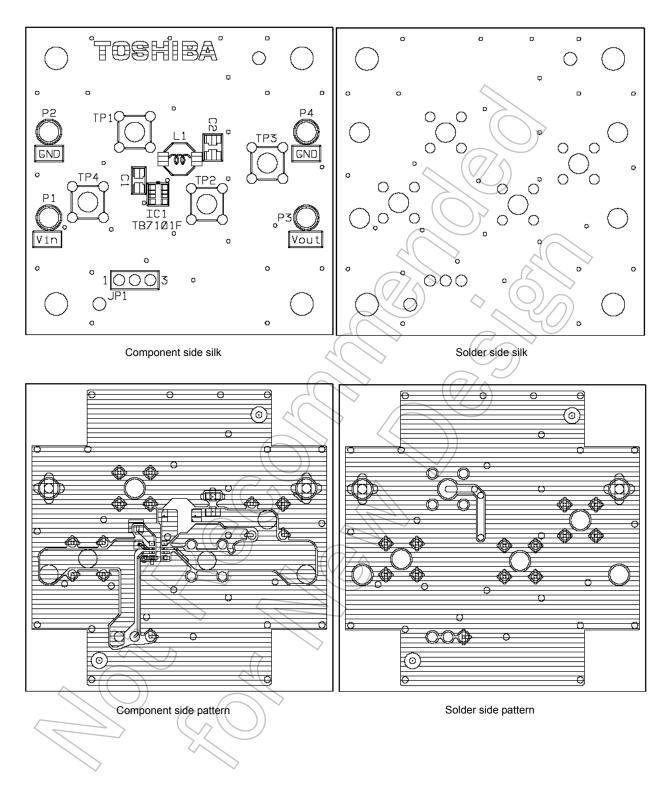
### **Typical Performance Characteristics**

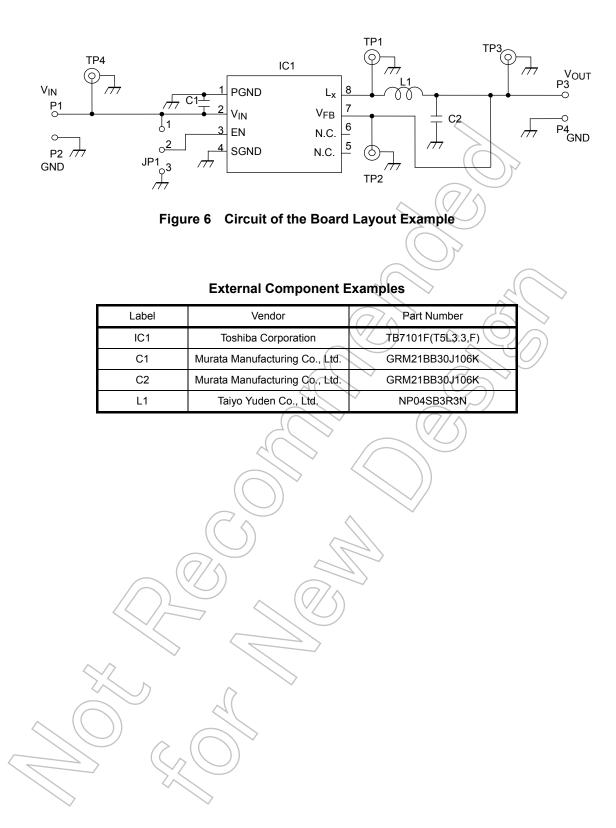






### Board Layout Example

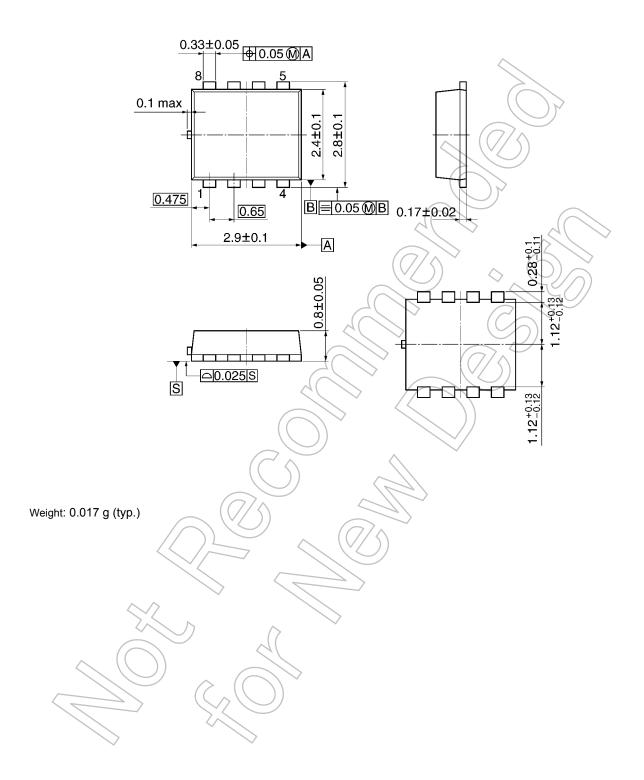




### Package Dimensions

SON8-P-0303-0.65A

Unit: mm



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